

■ **Features :**

- Package in 8mm tape on 7“ diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

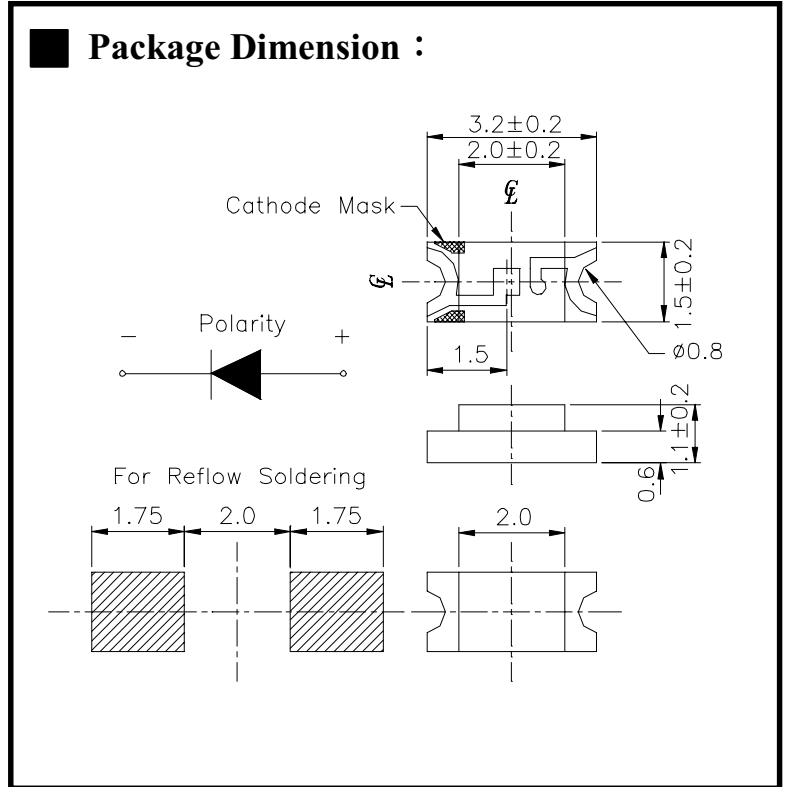
■ **Description :**

- The 15-21 SMD Taping is much smaller than leaded components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, light Weight makes them ideal for miniature application, etc.

■ **Applications :**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

■ **Package Dimension :**

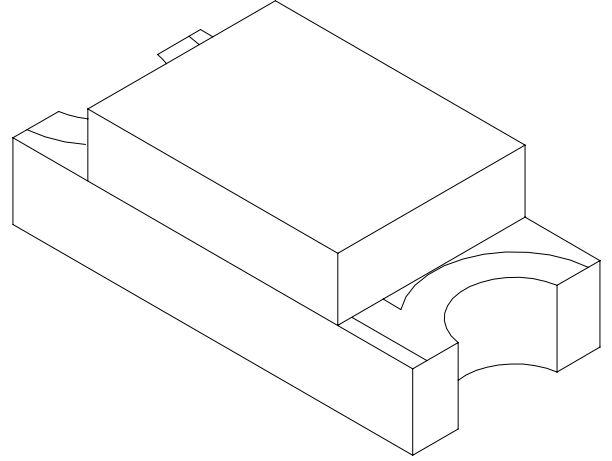
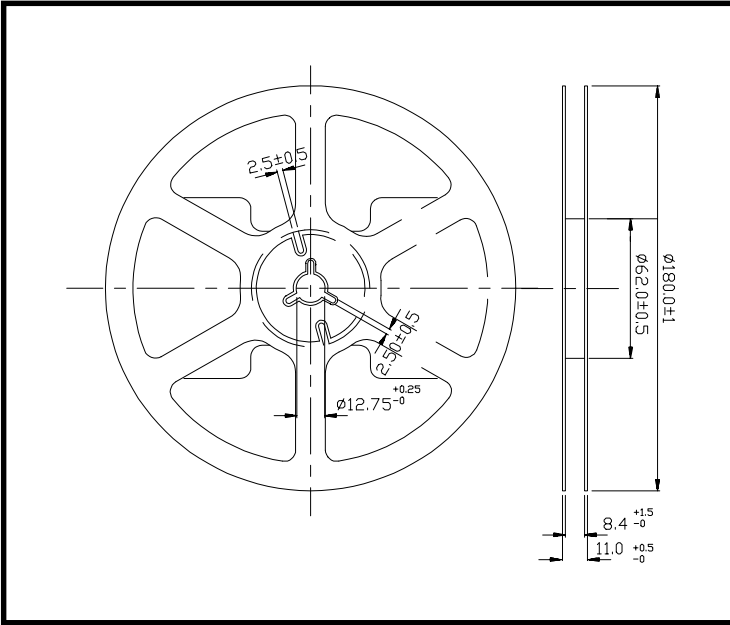


■ **Notes :**

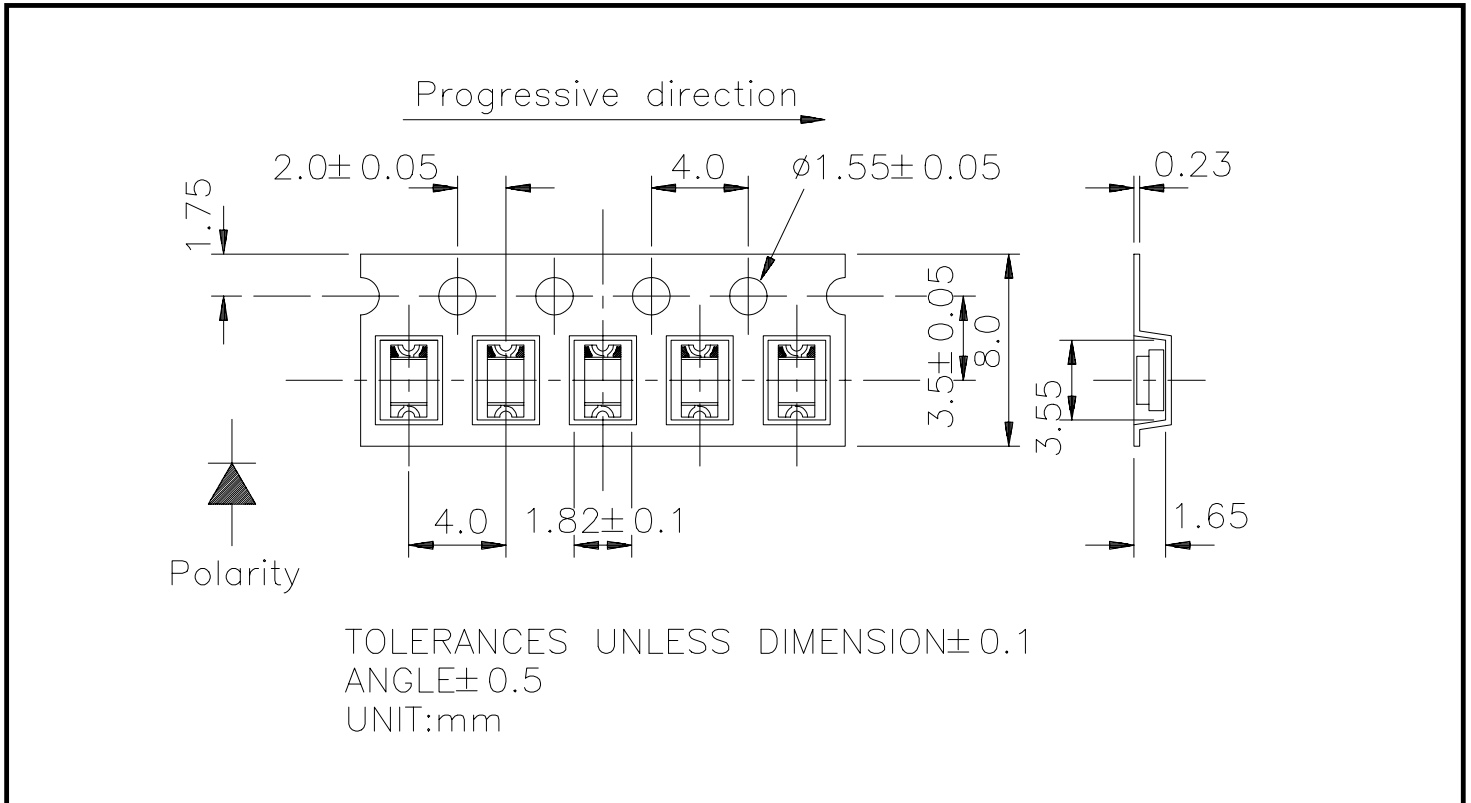
Tolerances Unless Dimension ±  
0.1mm  
Angle ±0.5°

PART NO	CHIP		Lens Color
	Material	Emitted Color	
15-21UYC/530-A2/TR8	AlGaInP	Super Yellow	Water Clear

■ **Package Dimension :**



■ **Loaded quantity per reel 2000 pcs/reel :**



■ **Absolute Maximum Ratings at Ta = 25°C**

Parameter	Symbol	Rating	Unit
Reverse Voltage	Vr	5	V
Forward Current	If	25	mA
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +90	°C
Soldering Temperature	Tsol	260 (for 5 second)	°C
Power Dissipation	Pd	60	mW
Peak Forward Current(Duty 1/10 @ 1KHZ)	If(Peak)	160	mA

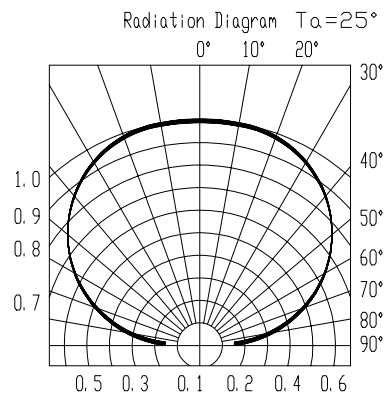
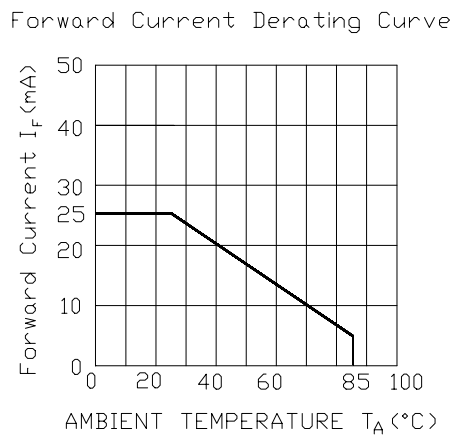
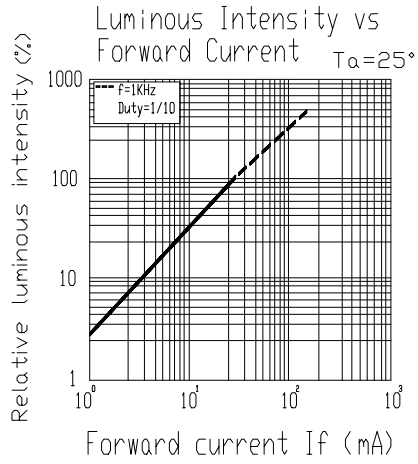
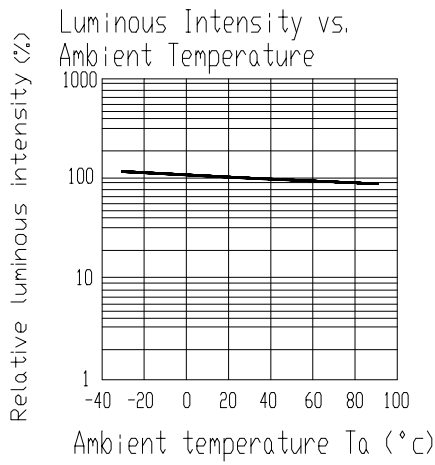
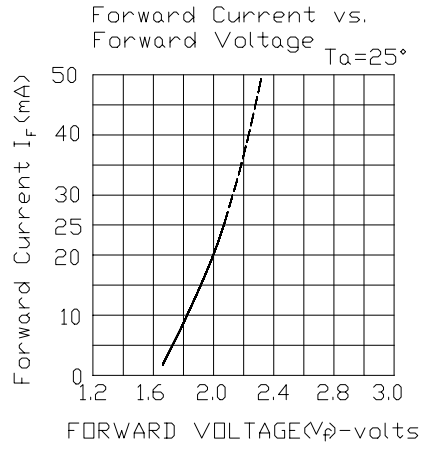
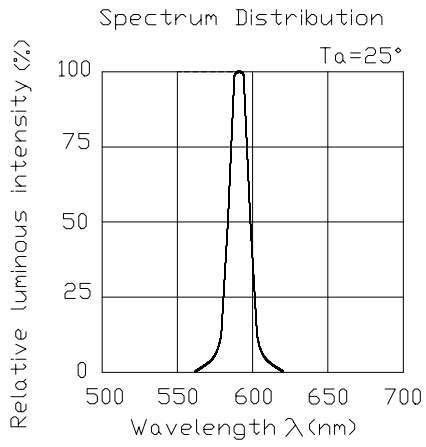
■ **Electronic Optical Characteristics :**

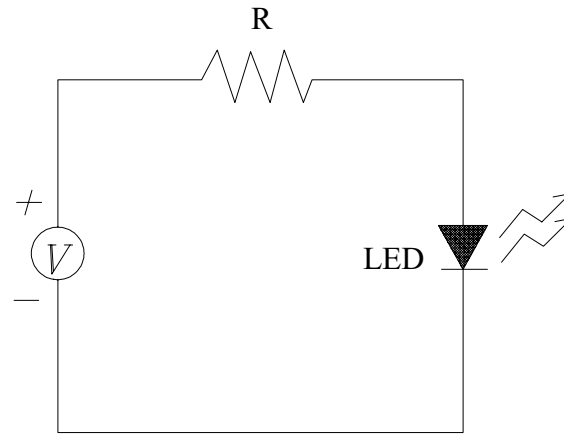
Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous intensity	Iv	15	39	-----	mcd	If=20mA
Viewing Angle	2θ 1/2	-----	140	-----	deg	If=20mA
Peak Wavelength	λ p	-----	591	-----	nm	If=20mA
Dominant Wavelength	λ d	-----	589	-----	nm	If=20mA
Spectrum Radiation Bandwidth	△ λ	-----	15	-----	nm	If=20mA
Forward Voltage	Vf	-----	2.0	2.4	V	If=20mA
Reverse Current	Ir	-----	-----	10	μ A	Vr=5V

■ Reliability Test Item And Condition

NO	Item	Test Conditions	Test Hours/Cycle	Sample Size	Ac/Re
1	Solder Heat	TEMP : 260°C ± 5 °C	5 SEC	76 Pcs	0/1
2	Temperature Cycle	H : +85°C 30min ∫ 5 min L : -55°C 30min	50 CYCLE	76 Pcs	0/1
3	Thermal Shock	H : +100°C 5min ∫ 10 sec L : -10°C 5min	50 CYCLE	76 Pcs	0/1
4	High Temperature Storage	TEMP : 100°C	1000 HRS	76 Pcs	0/1
5	Low Temperature Storage	TEMP : -55°C	1000 HRS	76 Pcs	0/1
6	DC Operating Life	If = 20 mA	1000 HRS	76 Pcs	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 HRS	76 Pcs	0/1

■ **Typical Electro-Optical Characteristic Curves**



**■ Test Circuit****■ Precautions For Use****1. Over-current-proof**

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change ( Burn out will happen ).

**2. Storage time**

2.1 The operation of temperature and R.H. are :  $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$  , R.H.60%.

2.2 Once the package is opened , the products should be used within a week.

Otherwise , they should be keep in a damp proof box with desiccants.

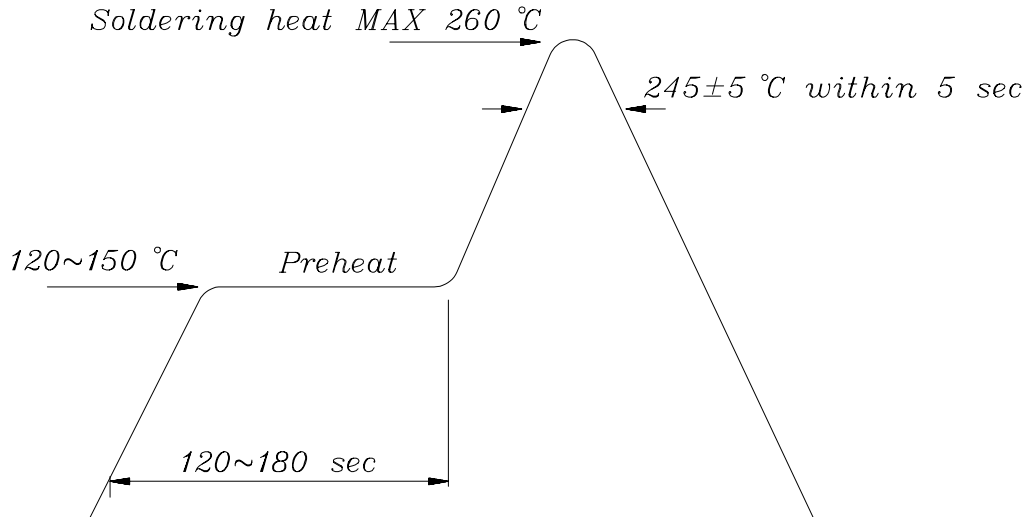
Considering the tape life , we suggest our customers to use our products within a year(from production date).

2.3 If opened more than one week in an atmosphere  $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$  , R.H.60%, they should be treated at  $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color (normal=blue) , you should treat them in the same conditions as 2.3.

## ■ Soldering heat reliability ( DIP )

Please refer to the following figure :

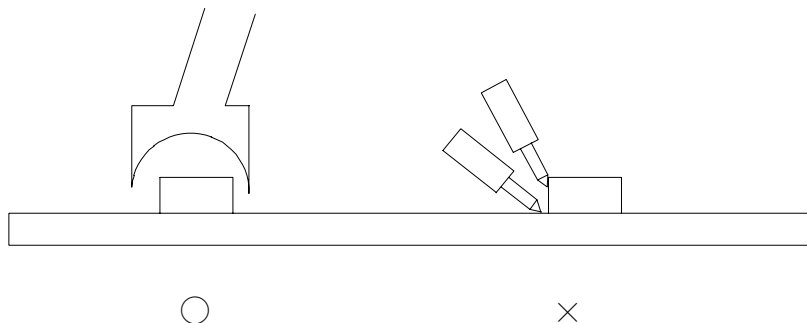


## ■ Soldering Iron

Basic spec is  $\leq 5$  sec when 260°C .If temperature is higher, time should be shorter (+10°C → -1sec). Power dissipation of iron should be smaller than 15 W , and temperature should be controllable.Surface temperature of the device should be under 230 °C .

## ■ Rework

1. Customer must finish rework within 5 sec under 260°C .
2. Copper foil can not be touched by the head of iron.
3. Twin-head type is preferred.



■ **Reflow**

